

LOCTITE ABLESTIK ATB 120U

June 2016

PRODUCT DESCRIPTION

LOCTITE ABLESTIK ATB 120U provides the following product characteristics:

Technology	Rubberized Epoxy	
Appearance	Transparent	
Cure	Heat cure	
Product Benefits	Non-conductive	
	Fast cure	
	Thin bondline	
	 Excellent gap filling ability 	
	 L2/260°C performance 	
рН	3.5	
Application	Die attach	
Filler Type	Silica	
Typical Package	Die to die stack	
Application		
Carrier Type	Polyolefin	
Adhesive Thickness	20μm	
Carrier Film Thickness	85µm	
Total Thickness	105 μm	
Wafer Size	8 and 12 in	

LOCTITE ABLESTIK ATB 120U adhesive film is formulated for use in wafer lamination processess. It combines process ease with the proven reliability.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Work Life @ 25°C, days	30
Shelf Life @ 5°C (from date of manufacture), days	274

TYPICAL PROCESS DATA

Wafer Backside Lamination

Temperature, °C	65 to 70
Pressure, psi	40
Taping Duration, ft/ minute	1

Chip Attach

Temperature, °C	100 to 120
Pressure, kg-f	0.5 to 2
Attach Duration, second	1 to 2

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minute ramp to 120°C + 30 minutes @ 120°C

Alternate Cure Schedule

30 minute ramp to 90°C + 30 minutes @ 90°C + 30 minute ramp to 120°C + 30 minutes @ 120°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers'

experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Coefficient of Thermal Expansion:	
Below Tg, ppm/°C	62
Above Tg, ppm/°C	238
Glass Transition Temperature (Tg) by TMA,	°C 75
Thermal Conductivity , W/(m-K)	0.21
Tensile Modulus, DMTA:	
@ -65 °C	N/mm ² 2,330 (psi) (337,940)
@ 25 °C	N/mm² 875 (psi) (126,880)
@ 100 °C	N/mm² 40 (psi) (5,360)
@ 150 °C	N/mm ² 3.0 (psi) (385)
@ 200 °C	N/mm ² 1.0 (psi) (175)
@ 250 °C	N/mm ² 2.0 (psi) (230)
Extractable Ionic Content, ppm:	. , , ,
Chloride (Cl-)	<10
Fluoride (F-)	<10
Sodium (Na+)	<10
Potassium (K+)	<10
Weight Loss @ 300°C, %	<1
Moisture Absorption @ Saturation, 85°C/85°RH	wt.% @ 1.5

TYPICAL PERFORMANCE OF CURED MATERIAL

Miscellaneous

Die Shear Strength vs Temperature, kg-f: 2.5 X 2.5 mm Si die frontside, kg-f,

@25°C	@260°C
40	2

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

DIRECTIONS FOR USE

- Ensure all surfaces to be bonded are free from surface contamination.
- Adhesive must be completely used within the product's recommended work life.



- 3. Remove the tape reel from the moisture-resistant package and load into the tape application machine.
- Store unused adhesive film in the original sealed moistureresistant package until needed.

Storage

These adhesive film should be stored at 5°C, in its original moisture resistant packaging. Partially used reels should be stored under dry conditions at 5°C.

To minimize moisture absorption, we recommend storing the adhesive film in the sealed moisture-resistant package until needed.

Optimal Storage: 5 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·m x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

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